



REF3312, REF3318 REF3320, REF3325 REF3330, REF3333

SBOS392A-AUGUST 2007-REVISED SEPTEMBER 2007

3.9µA, SC70-3, 30ppm/°C Drift VOLTAGE REFERENCE

FEATURES

• MICROSIZE PACKAGES: SC70-3, SOT23-3

LOW SUPPLY CURRENT: 3.9µA (typ)

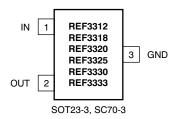
HIGH OUTPUT CURRENT: ±5mA

LOW TEMPERATURE DRIFT: 30ppm/°C (max)

HIGH INITIAL ACCURACY: ±0.15% (max)

APPLICATIONS

- PORTABLE EQUIPMENT
- DATA ACQUISITION SYSTEMS
- MEDICAL EQUIPMENT
- TEST EQUIPMENT



DESCRIPTION

The REF33xx is a low-power, precision, low-dropout voltage reference family available in the tiny SC70-3 and SOT23-3 packages. Small size and low power consumption (5 μ A max) make the REF33xx ideal for a wide variety of portable and battery-powered applications.

The REF33xx can be operated at a supply voltage 180mV above the specified output voltage under normal load conditions, with the exception of the REF3312, which has a minimum supply voltage of 1.8V. All models are specified for the wide temperature range, -40°C to +125°C.

REF33xx PRODUCT FAMILY

PRODUCT	DESCRIPTION
REF3312	1.25V
REF3318	1.8V
REF3320	2.048V
REF3325	2.5V
REF3330	3.0V
REF3333	3.3V

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION(1)

PRODUCT	DESCRIPTION	PACKAGE	PACKAGE DESIGNATOR	PACKAGE MARKING	
REF3312	1.25V	SOT23-3	DBZ	R33A	
KEF3312	1.25V	SC70-3	DCK	R12	
DEE2240	4.0)/	SOT23-3	DBZ	R33B	
REF3318	1.8V	SC70-3	DCK	R18	
REF3320	2.040\/	SOT23-3	DBZ	R33C	
KEF3320	2.048V	SC70-3	DCK	R20	
REF3325	2.5V	SOT23-3	DBZ	R33D	
KEF3325	2.5V	SC70-3	DCK	R25	
DEFOOO	2.01/	SOT23-3	DBZ	R33E	
REF3330	3.0V	SC70-3	DCK	R30	
REF3333	2.21/	SOT23-3	DBZ	R33F	
KEF3333	3.3V	SC70-3	DCK	R33	

⁽¹⁾ For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

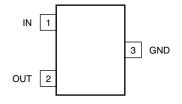
ABSOLUTE MAXIMUM RATINGS(1)

		VALUE	UNIT	
Input Voltage (V	(IN)	+7.5	V	
Output Short-Cir	cuit (I _{SC}) 180			
Output Voltage	(OUT pin) ⁽²⁾	5	V	
Operating Temperature		-50 to +150	°C	
Storage Temper	pperature —65 to +150		°C	
Junction Tempe	erature (T _J)	+150	°C	
	Human Body Model (HBM)	4000	V	
ESD Ratings	Charged Device Model (CDM)	1000	V	
	Machine Model (MM)	200	V	

⁽¹⁾ Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

PIN CONFIGURATION

REF3312, REF3318, REF3320, REF3325, REF3330, REF3333 SOT23-3, SC70-3 TOP VIEW



⁽²⁾ See the Applications Information section, Supply Voltage.



ELECTRICAL CHARACTERISTICS: V_{IN} = +5V

Boldface limits apply over the specified temperature range, -40° C to $+125^{\circ}$ C. At T_A = $+25^{\circ}$ C and I_{LOAD} = 0mA, unless otherwise noted.

			REF33xx		
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
	REF3312 (1.25V)				
OUTPUT VOLTAGE					
Initial Accuracy V _{OUT}	$V_{IN} = 5V$		1.25		V
		-0.15		+0.15	%
NOISE					
Output Voltage Noise	f = 0.1Hz to $10Hz$		35		μV_{PP}
	REF3318 (1.8V)				
OUTPUT VOLTAGE					
Initial Accuracy V _{OUT}	$V_{IN} = 5V$		1.8		V
		-0.15		+0.15	%
NOISE					
Output Voltage Noise	f = 0.1Hz to $10Hz$		50		μV_{PP}
	REF3320 (2.048V)	<u> </u>			
OUTPUT VOLTAGE					
Initial Accuracy V _{OUT}	$V_{IN} = 5V$		2.048		V
		-0.15		+0.15	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		55		μV_{PP}
,	REF3325 (2.5V)	1	11		
OUTPUT VOLTAGE					
Initial Accuracy V _{OUT}	$V_{IN} = 5V$		2.5		V
		-0.15		+0.15	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		70		μV_{PP}
,	REF3330 (3.0V)	<u> </u>	1		-
OUTPUT VOLTAGE					
Initial Accuracy V _{OUT}	$V_{IN} = 5V$		3.0		V
		-0.15		+0.15	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		84		μV_{PP}
	REF3333 (3.3V)		1	1	1
OUTPUT VOLTAGE					
Initial Accuracy V _{OUT}	$V_{IN} = 5V$		3.3		V
5		-0.15		+0.15	%
NOISE					
Output Voltage Noise	f = 0.1Hz to 10Hz		92		μV_{PP}



ELECTRICAL CHARACTERISTICS: V_{IN} = +5V (continued)

Boldface limits apply over the specified temperature range, -40° C to $+125^{\circ}$ C. At T_A = $+25^{\circ}$ C and I_{LOAD} = 0mA, unless otherwise noted.

			REF33xx		
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
REF33xx (REF3	312, REF3318, REF3320, REF3325,	REF3330, REF33	33)		
OUTPUT VOLTAGE TEMPERATURE DRIFT					
dV _{OUT} /dT	-40°C to +85°C		9	30	ppm/°C
	-40°C to +125°C		8	30	ppm/°C
LINE REGULATION	$V_{IN} = V_{OUT} + 200 \text{mV to } 5.5 \text{V}^{(1)}$	-50	6	+50	ppm/V
dV_{OUT}/dV_{IN}	0°C to +70°C		6		ppm/V
Over Temperature	-40°C to +85°C		8		ppm/V
	-40°C to +125°C		30		ppm/V
LOAD REGULATION	$V_{IN} = V_{OUT} + 200 \text{mV}^{(1)}$	-50	6	+50	ppm/mA
dV_{OUT}/dI_{LOAD}	$I_{LOAD} = \pm 5$ mA, 0°C to $+70$ °C		10		ppm/mA
Over Temperature	-40°C to +85°C		20		ppm/mA
	-40°C to +125°C		20		ppm/mA
THERMAL HYSTERESIS dT ⁽²⁾					
			90		ppm
MINIMUM DROPOUT VOLTAGE $V_{IN} - V_{OUT}^{(1)}$	$I_{LOAD} = \pm 5mA$		110	160	mV
Over Temperature	0°C to +70°C		120		mV
	-40°C to +85°C		135		mV
	-40°C to +125°C		180		mV
	$I_{LOAD} = \pm 2mA$, $-40^{\circ}C$ to $+85^{\circ}C$			70	mV
SHORT-CIRCUIT CURRENT					
Sourcing/Sinking I _{SC}			35		mA
CAPACITIVE LOAD					
		0.1		10	μF
TURN-ON SETTLING TIME					
	To 0.1% with $C_L = 1\mu F$		2		ms
POWER SUPPLY					
Specified Voltage Range V _S		V _{OUT} + 0.2 ⁽¹⁾		5.5	V
Operating Voltage Range	$I_{LOAD} = 0mA$		V _{OUT} + 0.005	5.5	V
Current I _Q	$V_{IN} = 5V$		3.9	5	μA
Over Temperature	-40°C to +85°C		4.4	6.5	μA
	-40°C to +125°C		4.8	8.5	μ Α
TEMPERATURE RANGE					
Specified Range T _A		-40		+125	°C
Operating Range T _A		-50		+150	°C
Thermal Resistance θ_{JA}					
SC70-3			300		°C/W
SOT23-3			300		°C/W

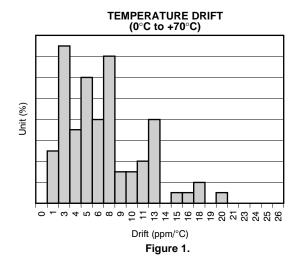
⁽¹⁾ The minimum supply voltage for the REF3312 is 1.8V.

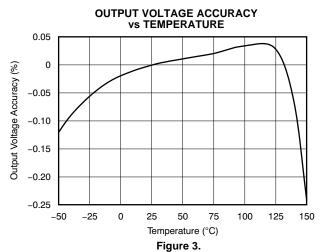
⁽²⁾ The thermal hysteresis procedure is explained in more detail in the *Applications Information* section.

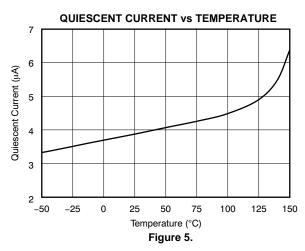


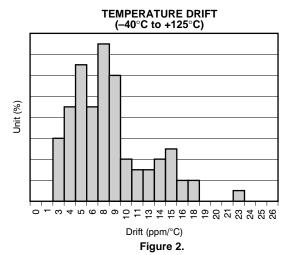
TYPICAL CHARACTERISTICS

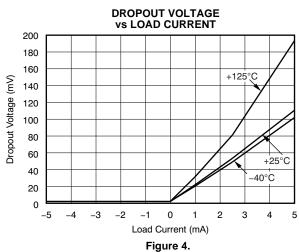
At $T_A = +25$ °C and $V_{IN} = +5$ V. REF3325 is used for typical characteristic measurements, unless otherwise noted.

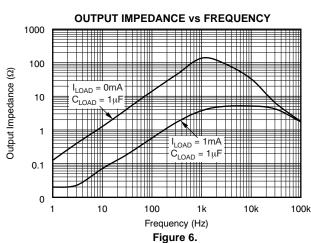








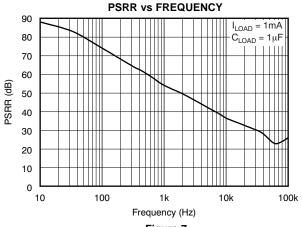




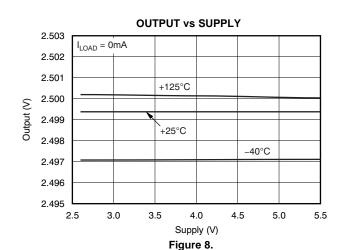


TYPICAL CHARACTERISTICS (continued)

At $T_A = +25$ °C and $V_{IN} = +5$ V. REF3325 is used for typical characteristic measurements, unless otherwise noted.









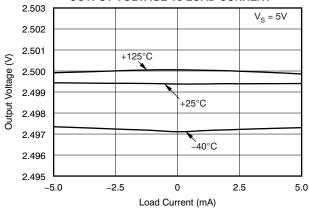


Figure 9.

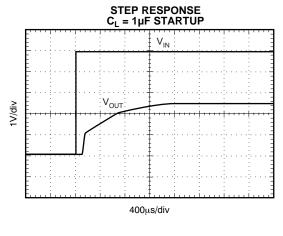
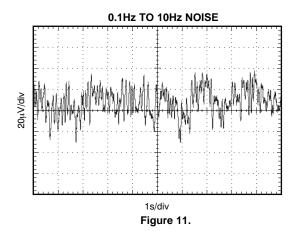


Figure 10.



LINE TRANSIENT (C_L = 1µF, I_{OUT} = 0mA)

V_{IN}

V_{IN}

V_{OUT}

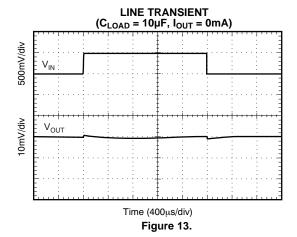
100µs/div

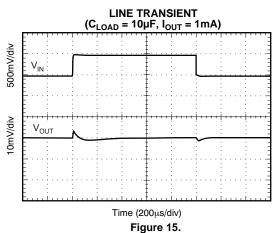
Figure 12.

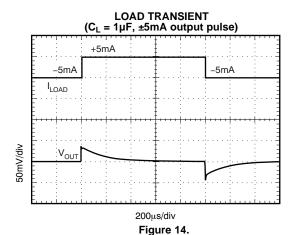


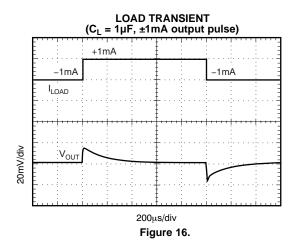
TYPICAL CHARACTERISTICS (continued)

At $T_A = +25$ °C and $V_{IN} = +5$ V. REF3325 is used for typical characteristic measurements, unless otherwise noted.









APPLICATIONS INFORMATION

The REF33xx is a family of low-power, precision bandgap voltage references that are specifically designed for excellent initial voltage accuracy with a high output current. Figure 17 shows a simplified block diagram of the REF33xx.

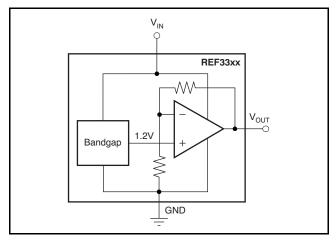


Figure 17. REF33xx Simplified Block Diagram

BASIC CONNECTIONS

Figure 18 shows the typical connections for the REF33xx. A recommended supply bypass capacitor ranging between $1\mu\text{F}$ to $10\mu\text{F}$ is recommended. The total capacitive load at the output must be between $0.1\mu\text{F}$ to $10\mu\text{F}$ to ensure output stability.

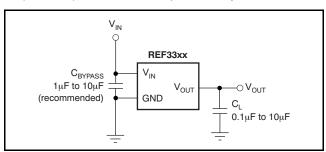


Figure 18. Basic Connections

SUPPLY VOLTAGE

The REF33xx family of voltage references features extremely low dropout voltage, except for the REF3312. The REF3312 has a minimum supply requirement of 1.8V. These references can be operated with a supply 110mV above the output voltage with a 5mA load (typical). For loaded conditions, a typical dropout voltage versus load graph is illustrated in Figure 4 of the *Typical Characteristics*.

If the supply voltage connected to the IN pin is rapidly moved while the REF33xx is connected to a capacitive load, a reverse voltage may discharge through the OUT pin and into the REF33xx device. This voltage will not damage the REF33xx, provided that it is less than or equal to 5V.

START-UP TIME

The REF33xx features an advanced start-up circuit. Start-up time is almost independent of load (with a 0.1µF to 10µF load). Upon start-up, the current boost circuit forces the output voltage. When the preset voltage is reached, the REF33xx switches to the second stage of output circuitry to precisely set the output voltage. Figure 19 shows the start-up time of the REF3325 for three different capacitive loads. In all three cases, the output voltage settles within 2ms.

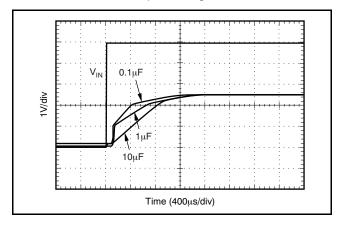


Figure 19. Start-Up Time

TEMPERATURE DRIFT

The REF33xx is designed for minimal drift error, defined as the change in output voltage over temperature. The drift is calculated using the box method, as described in Equation 1:

Drift =
$$\left(\frac{V_{OUTMAX} - V_{OUTMIN}}{V_{OUT} \times \text{Temp Range}}\right) \times 10^{6} \text{(ppm)}$$
(1)



POWER DISSIPATION

The REF33xx family is specified to deliver current loads of ±5mA over the specified input voltage range. The temperature of the device increases according to Equation 2:

$$T_{J} = T_{A} + P_{D} \times \theta_{JA} \tag{2}$$

Where:

 T_J = Junction temperature (°C)

 T_A = Ambient temperature (°C)

P_D = Power dissipation (W)

Where $P_D = V_{IN} \times I_Q + (V_{IN} - V_{OUT}) I_{OUT}$

 θ_{JA} = Junction-to-ambient thermal resistance (°C/W)

The REF33xx junction temperature must not exceed the absolute maximum rating of +150°C.

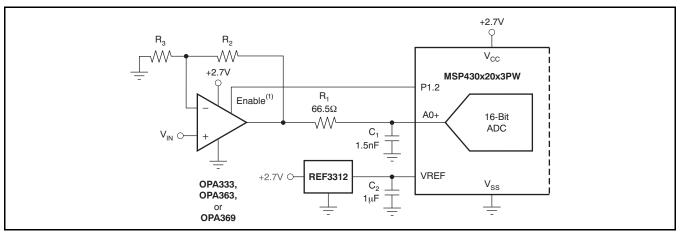
NOISE PERFORMANCE

Typical 0.1Hz to 10Hz voltage noise for each member of the REF33xx family is specified in the *Electrical Characteristics* table. The noise voltage increases with output voltage and operating temperature. Additional filtering can be used to improve output noise levels. Special attention should be taken to ensure that the output impedance does not degrade output voltage accuracy.

APPLICATION CIRCUITS

Figure 20 shows a simple application circuit where low-power components are used to create a signal chain. The analog input signal is buffered with either a zero-drift OPA333 or zero-crossover OPA363. The reference voltage created from REF3312 provides a stable, high-accuracy, low-drift reference voltage to the MSP430 using much less power than the MSP430 internal reference. The reference voltage is used by the internal, 16-bit analog-to-digital converter (ADC) to accurately convert the analog input signal. The configuration in Figure 20 presents an example of a unipolar signal chain.

An example of a bipolar configuration is illustrated in Figure 21. The analog input signal (±2.5V) is offset and attenuated so that it matches the analog input of the 16-bit ADC on the MSP430. The negative input of the ADC is offset by 0.62V, creating a digital code that corresponds to the analog input voltage. In this configuration, two reference voltages are used. The REF3312 creates a 1.25V reference input to the ADC and is an offset point for the INA159. The same voltage is used to create the offset voltage to the negative input to the ADC. The REF3330 creates a precise analog supply voltage of 3V. In this way, the high PSRR of the REF3330 helps to filter unwanted noise from the 3.3V digital supply.



(1) Enable is a function of the OPA363 not available on the OPA333.

Figure 20. Unipolar Signal Chain Configuration



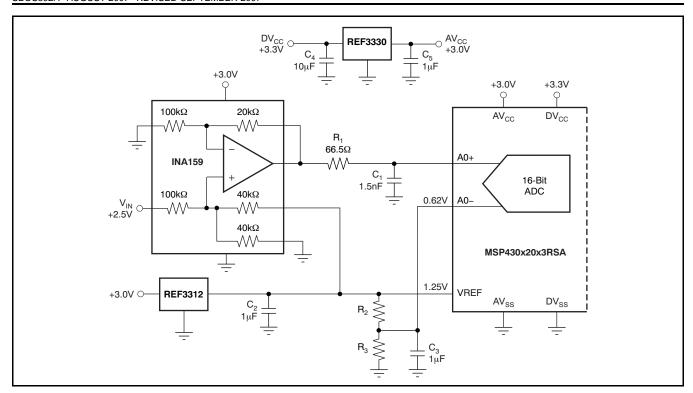


Figure 21. Bipolar Signal Chain Configuration

PACKAGE OPTION ADDENDUM



2-Oct-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
REF3312AIDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3312AIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3312AIDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3312AIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3312AIDCKR	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3312AIDCKRG4	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3312AIDCKT	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3312AIDCKTG4	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDCKR	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDCKRG4	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDCKT	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3318AIDCKTG4	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDCKR	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDCKRG4	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDCKT	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3320AIDCKTG4	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3325AIDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR





2-Oct-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
REF3325AIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3325AIDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3325AIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3325AIDCKR	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3325AIDCKRG4	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3325AIDCKT	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3325AIDCKTG4	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDCKR	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDCKRG4	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDCKT	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3330AIDCKTG4	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDBZR	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDBZRG4	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDBZT	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDBZTG4	ACTIVE	SOT-23	DBZ	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDCKR	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDCKRG4	ACTIVE	SC70	DCK	3	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDCKT	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
REF3333AIDCKTG4	ACTIVE	SC70	DCK	3	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

PACKAGE OPTION ADDENDUM



i.com 2-Oct-2007

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE MATERIALS INFORMATION

16-Feb-2009

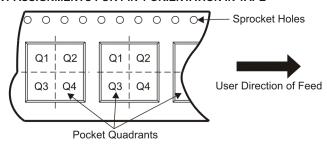
TAPE AND REEL INFORMATION



TAPE DIMENSIONS $\Phi \Phi \Phi \Phi$ Cavity -→ A0 **←**

	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



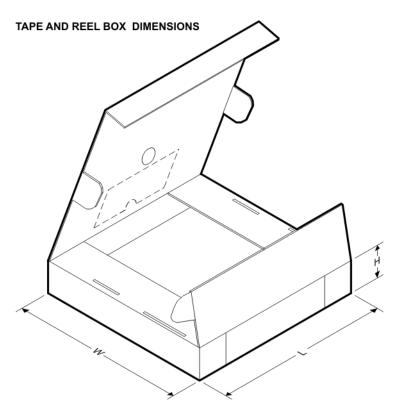
*All dimensions are nominal	I		I		T							
Device	Package Type	Package Drawing		SPQ	Reel Diameter	Reel Width	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
					(mm)	W1 (mm)						
REF3312AIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3312AIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3312AIDCKR	SC70	DCK	3	3000	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3312AIDCKT	SC70	DCK	3	250	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3318AIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3318AIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3318AIDCKR	SC70	DCK	3	3000	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3318AIDCKT	SC70	DCK	3	250	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3320AIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3320AIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3320AIDCKR	SC70	DCK	3	3000	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3320AIDCKT	SC70	DCK	3	250	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3325AIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3325AIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3325AIDCKR	SC70	DCK	3	3000	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3325AIDCKT	SC70	DCK	3	250	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3330AIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3330AIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3





tom 16-Feb-2009

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
REF3330AIDCKR	SC70	DCK	3	3000	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3330AIDCKT	SC70	DCK	3	250	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3333AIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3333AIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
REF3333AIDCKR	SC70	DCK	3	3000	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3
REF3333AIDCKT	SC70	DCK	3	250	179.0	8.4	2.4	2.4	1.19	4.0	8.0	Q3



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
REF3312AIDBZR	SOT-23	DBZ	3	3000	195.0	200.0	45.0
REF3312AIDBZT	SOT-23	DBZ	3	250	195.0	200.0	45.0
REF3312AIDCKR	SC70	DCK	3	3000	195.0	200.0	45.0
REF3312AIDCKT	SC70	DCK	3	250	195.0	200.0	45.0
REF3318AIDBZR	SOT-23	DBZ	3	3000	195.0	200.0	45.0
REF3318AIDBZT	SOT-23	DBZ	3	250	195.0	200.0	45.0
REF3318AIDCKR	SC70	DCK	3	3000	195.0	200.0	45.0
REF3318AIDCKT	SC70	DCK	3	250	195.0	200.0	45.0
REF3320AIDBZR	SOT-23	DBZ	3	3000	195.0	200.0	45.0
REF3320AIDBZT	SOT-23	DBZ	3	250	195.0	200.0	45.0
REF3320AIDCKR	SC70	DCK	3	3000	195.0	200.0	45.0



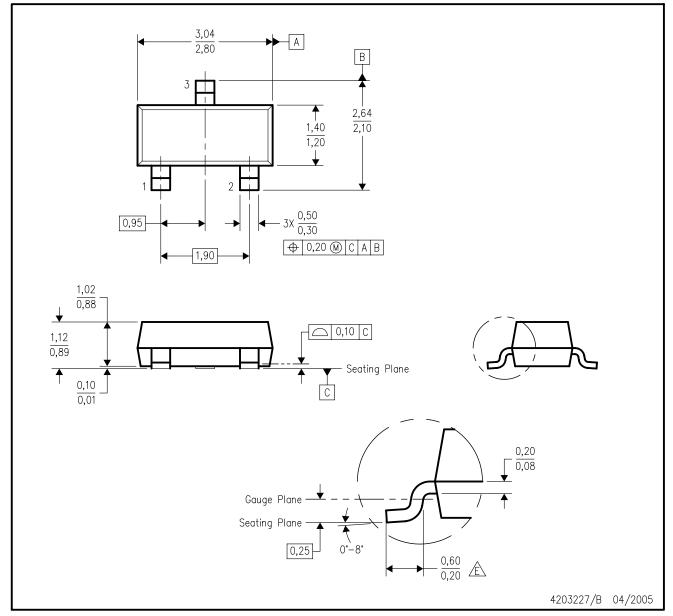
PACKAGE MATERIALS INFORMATION

16-Feb-2009

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
REF3320AIDCKT	SC70	DCK	3	250	195.0	200.0	45.0
REF3325AIDBZR	SOT-23	DBZ	3	3000	195.0	200.0	45.0
REF3325AIDBZT	SOT-23	DBZ	3	250	195.0	200.0	45.0
REF3325AIDCKR	SC70	DCK	3	3000	195.0	200.0	45.0
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REF3330AIDBZR	SOT-23	DBZ	3	3000	195.0	200.0	45.0
REF3330AIDBZT	SOT-23	DBZ	3	250	195.0	200.0	45.0
REF3330AIDCKR	SC70	DCK	3	3000	195.0	200.0	45.0
REF3330AIDCKT	SC70	DCK	3	250	195.0	200.0	45.0
REF3333AIDBZR	SOT-23	DBZ	3	3000	195.0	200.0	45.0
REF3333AIDBZT	SOT-23	DBZ	3	250	195.0	200.0	45.0
REF3333AIDCKR	SC70	DCK	3	3000	195.0	200.0	45.0
REF3333AIDCKT	SC70	DCK	3	250	195.0	200.0	45.0

DBZ (R-PDSO-G3)

PLASTIC SMALL-OUTLINE

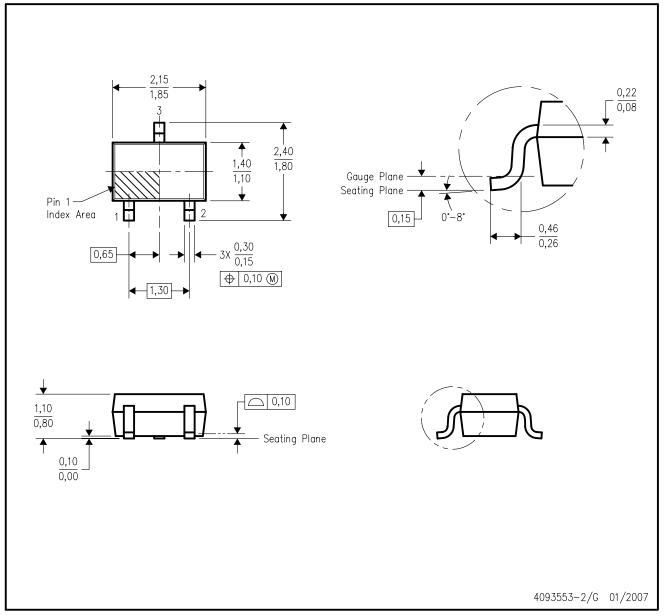


NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Lead dimensions are inclusive of plating.
- D. Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side.
- Falls within JEDEC TO-236 variation AB, except minimum foot length.

DCK (R-PDSO-G3)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.

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